

	9144030070855050X9		
	A1 A3		0755-33810388
	<p style="text-align: center;">(Printed Circuit Board PCB) (High Density Interconnection HDI) (Flexible Printed Circuit FPC) (Rigid Printed Circuit Board)</p> <p style="text-align: right;">ISO9001</p> <p>ISO14001 ISO14064 OHSAS18001 ISO50001 QC080000</p>		

					1		
			/	mg/L		mg/L	
				0.04	0.06	0.5	
				0.31	0.44	2	
				0.01	0.01	0.4	
				0.19	0.27	4	
			COD	64.00	91.14	160	
				0.24	0.33	1.0	
				7.32	10.43	30	
				9.05	12.88	40	
			DB44/1597-2015 1				
			200%				

					1		
			/	mg/m ³		mg/m ³	
				0.38	0.38	7	
				1.23	4.41	30	
				0.10	0.39	30	
				3.38	4.60	200	
				0.0048	0.0222	0.5	
				0	N/A	0.05	
			VOCs	4.63	4.69	80	
		GB21900-2008 5					
		VOCs					
		DB44/815-2010 2					

		()	()		
		1786.49	1786.49		
		8192.929	8192.929		

		()	()		
		27.53	27.53		
		11.94	11.94		
		28.6	28.6		
		3.863	3.863		
		321.96	320.96		
		16.11	16.11		1.
		1402.83	1399.83		
		172.54	171.54		
		12.245	12.245		
		19.945	19.945		
		369.28	368.28		2.
		0.67	0.67		
		50.38	50.38		
		1.44	1.44		
		5202.86	5198.86		3.
		5058.59	5048.59		
		20.67	20.67		
		3.01	3.01		
		40.553	40.553		4.
		1010.43	1007.43		
		318.83	318.83		
		1172.33	1169.33		
		0.14	0.14		
		1.402	1.402		5.

		()	()		
		4.29	4.29	6. SMT () PP) B () 7. 8. / FPC A A	
	A	167.0016	167.0016		
	()	49.774	49.774		
		12.042	12.042		
	PP	29.987	29.987		
		213.71	210.71		
		16.8464	16.8464		
	SMT	0.4544	0.4544		
	()	191.8416	191.8416		
		89.5812	89.5812		
	B	46.39	46.39		
	FPC A	46.71	46.71		
	HDI A	25.72	25.72		
	HDI A	96.462	96.462		
	FPC A	8.4912	8.4912		
	HDI B	20.257	20.257		
	FPC B	1.143	1.143		
	HDI C	14.371	14.371		

		Leq	Leq	Leq	Leq
	1	59.7	49.6	65	55
	1	60.3	49.9		
	1	59.4	50.2		
	1	58.3	49.3		

		2006 12	12000 /	
		2006 12	129.9 /	
	()	2018 6	26.6 /	

()		2005-1 2-23	[2005]213			

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() ” 200-1
T40 200558(40 Td90558(40 Td90558(6 /R114253 191)-

			2020-1-21
	1		“ ”
	2	“	”
	3		

